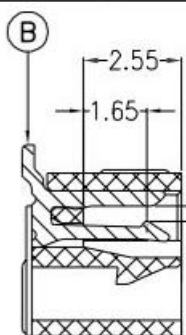
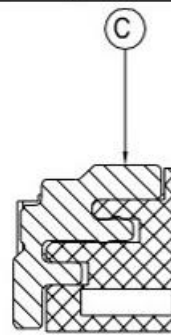


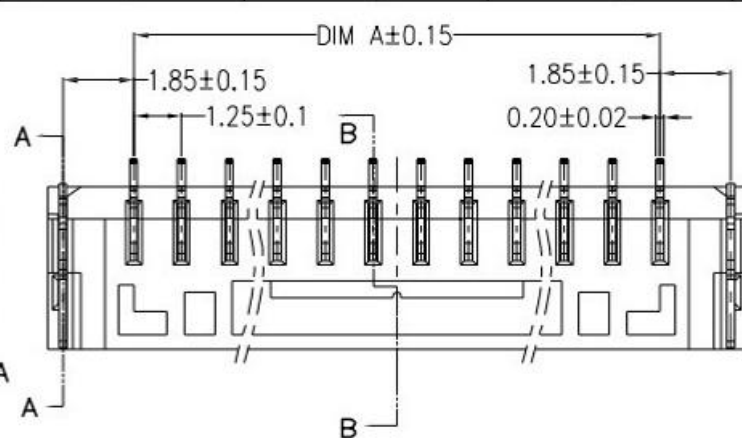
A



SECTION B-B



SECTION A-A



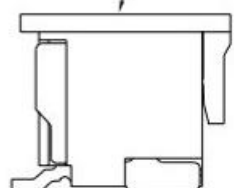
模号位置

DIM C $\begin{smallmatrix} +0.2 \\ -0.1 \end{smallmatrix}$

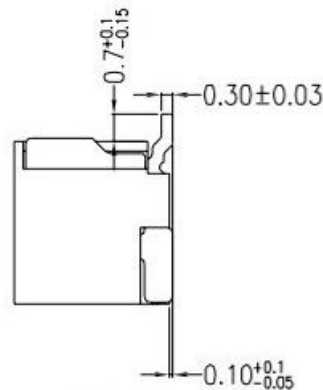
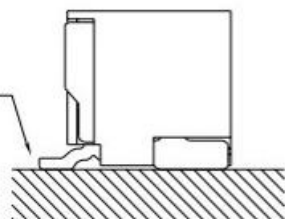
1.60 $\begin{smallmatrix} +0.15 \\ -0.10 \end{smallmatrix}$
4.25 ± 0.15

0.65 ± 0.1
CAP (Apply to Reel)

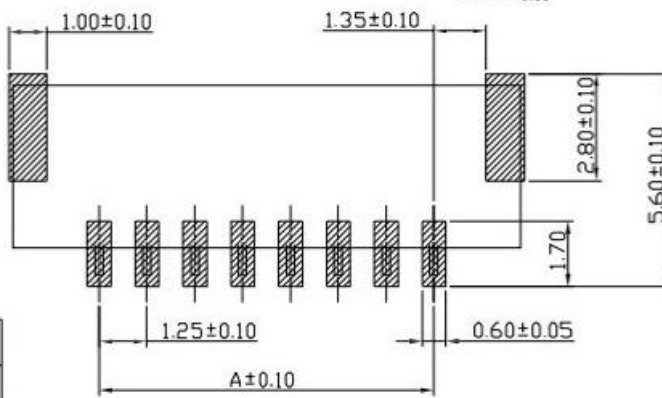
0.60 $\begin{smallmatrix} +0.15 \\ -0.05 \end{smallmatrix}$



0.10



0.10 $\begin{smallmatrix} +0.1 \\ -0.05 \end{smallmatrix}$



SUGGESTED PCB LAYOUT
(COMPONENT SIDE)

主要技术参数 Main Specifications

- 线数 (Poles): 02 to 15
- 接触电阻 (Contact resistance): $\leq 20m\Omega$
- 绝缘电阻 (Insulation resistance): $\geq 100M\Omega$
- 额定电压 (Rated voltage): 50V AC DC
- 额定电流 (Rated current): 1.0A AC DC
- 耐电压 (Withstand Voltage): 500V AC/minute
- 温度范围 (Temperature Range): $-40^{\circ}C \sim +110^{\circ}C$

NO.	DESCRIPTION	QTY	MATERIAL	PLATING/COLOR
A	Insulator	1	LCP (UL94V-0)	Beige
B	Contacts	2~15	PhosphorBronze	Tin-plated
C	Solder Tab	2	PhosphorBronze	Tin-plated

孔位	尺寸	DIM A	DIM B	DIM C	孔位	尺寸	DIM A	DIM B	DIM C
2P		1.25	5.75	3.95	9P		10.00	14.50	12.70
3P		2.50	7.00	5.20	10P		11.25	15.75	13.95
4P		3.75	8.25	6.45	11P		12.50	17.00	15.20
5P		5.00	9.50	7.70	12P		13.75	18.25	16.45
6P		6.25	10.75	8.95	13P		15.00	19.50	17.70
7P		7.50	12.00	10.20	14P		16.25	20.75	18.95
8P		8.75	13.25	11.45	15P		17.50	22.00	20.20

UNITS
mm
MAT'L

X ± 0.3	X' ± 5°	FINISH
.X ± 0.25	.X' ± 2°	
.XX ± 0.20	.XX' ± 1°	
.XXX ± 0.10	.XXX' ± 0.5°	

Q'TY
PCS

科斯达电子科技有限公司

PART NO. (INTENDED USE)	TITLE:
APPD:	DWG NO.:
CHKD:	
DR: HU 2016.09.28	



SCALE	SHEET	REV.
1/1	1/1	A